

# BFP640ESD

Robust Low Noise Silicon Germanium Bipolar RF Transistor

## Data Sheet

Revision 1.1, 2012-09-17

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## BFP640ESD, Robust Low Noise Silicon Germanium Bipolar RF Transistor

### Revision History: 2012-09-17, Revision 1.1

| Page | Subjects (major changes since previous revision)                                                                                                                                                                                                               |
|------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|      | This data sheet replaces the revision from 2010-06-29.<br>The product itself has not been changed and the device characteristics remain unchanged.<br>Only the product description and information available in the data sheet have been expanded and updated. |
|      |                                                                                                                                                                                                                                                                |
|      |                                                                                                                                                                                                                                                                |

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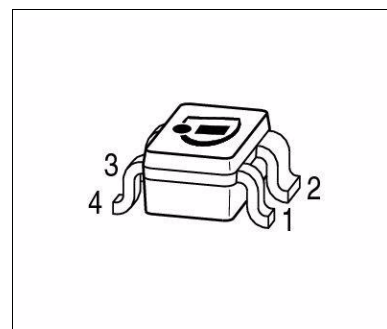
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## 1 Product Brief

The BFP640ESD is a very low noise wideband NPN bipolar RF transistor. The device is based on Infineon's reliable high volume silicon germanium carbon (SiGe:C) heterojunction bipolar technology. The collector design supports voltages up to  $V_{CE0} = 4.1\text{ V}$  and currents up to  $I_C = 50\text{ mA}$ . The device is especially suited for mobile applications in which low power consumption is a key requirement. The typical transition frequency is approximately 45 GHz, hence the device offers high power gain at frequencies up to 10 GHz in amplifier applications. The transistor is fitted with internal protection circuits, which enhance the robustness against electrostatic discharge (ESD) and high levels of RF input power. The device is housed in an easy to use plastic package with visible leads.

## 2 Features

- Robust very low noise amplifier based on Infineon's reliable, high volume SiGe:C wafer technology
- 2 kV ESD robustness (HBM) due to integrated protection circuits
- High maximum RF input power of 21 dBm
- 0.65 dB minimum noise figure typical at 1.5 GHz, 0.7 dB at 2.4 GHz, 6 mA
- 26.5 dB maximum gain  $G_{ms}$  typical at 1.5 GHz, 23 dB  $G_{ms}$  at 2.4 GHz, 30 mA
- 27 dBm  $OIP_3$  typical at 2.4 GHz, 30 mA
- Easy to use Pb-free (RoHS compliant) and halogen-free standard package with visible leads
- Qualification report according to AEC-Q101 available



## Applications

As Low Noise Amplifier (LNA) in

- Mobile portable and fixed connectivity applications: WLAN 802.11a/b/g/n, WiMAX 2.5 / 3.5 / 5 GHz, UWB, Bluetooth
- Satellite communication systems: Navigation systems (GPS, Glonass), satellite radio (SDARs, DAB) and C-band LNB
- Multimedia applications such as mobile / portable TV, CATV, FM radio
- 3G/4G UMTS/LTE mobile phone applications
- ISM applications like RKE, AMR and Zigbee, as well as for emerging wireless applications

As discrete active mixer, amplifier in VCOs and buffer amplifier

**Attention: ESD (Electrostatic discharge) sensitive device, observe handling precautions**

| Product Name | Package | Pin Configuration |       |       |       | Marking |
|--------------|---------|-------------------|-------|-------|-------|---------|
| BFP640ESD    | SOT343  | 1 = B             | 2 = E | 3 = C | 4 = E | T4s     |

### 3 Maximum Ratings

**Table 3-1 Maximum Ratings at  $T_A = 25\text{ °C}$  (unless otherwise specified)**

| Parameter                               | Symbol     | Values |      | Unit | Note / Test Condition                       |
|-----------------------------------------|------------|--------|------|------|---------------------------------------------|
|                                         |            | Min.   | Max. |      |                                             |
| Collector emitter voltage               | $V_{CEO}$  | –      | 4.1  | V    | Open base<br>$T_A = 25\text{ °C}$           |
|                                         |            | –      | 3.6  | V    | $T_A = -55\text{ °C}$                       |
| Collector base voltage <sup>1)</sup>    | $V_{CBO}$  | –      | 4.8  | V    | Open emitter<br>$T_A = 25\text{ °C}$        |
|                                         |            | –      | 4.3  | V    | $T_A = -55\text{ °C}$                       |
| Collector emitter voltage <sup>2)</sup> | $V_{CES}$  | –      | 4.1  | V    | E-B short circuited<br>$T_A = 25\text{ °C}$ |
|                                         |            | –      | 3.6  | V    | $T_A = -55\text{ °C}$                       |
| Base current <sup>3)</sup>              | $I_B$      | -10    | 6    | mA   | –                                           |
| Collector current                       | $I_C$      | –      | 50   | mA   | –                                           |
| RF input power <sup>4)</sup>            | $P_{RFin}$ | –      | 21   | dBm  | –                                           |
| ESD stress pulse <sup>5)</sup>          | $V_{ESD}$  | -2     | 2    | kV   | HBM, all pins, acc. to JESD22-A114          |
| Total power dissipation <sup>6)</sup>   | $P_{tot}$  | –      | 200  | mW   | $T_S \leq 88\text{ °C}$                     |
| Junction temperature                    | $T_J$      | –      | 150  | °C   | –                                           |
| Storage temperature                     | $T_{Stg}$  | -55    | 150  | °C   | –                                           |

1) Low  $V_{CBO}$  due to integrated protection circuits.

2)  $V_{CES}$  is identical to  $V_{CEO}$  due to integrated protection circuits.

3) Sustainable reverse bias current is high due to integrated protection circuits.

4) RF input power is high due to integrated protection circuits.

5) ESD robustness is high due to integrated protection circuits.

6)  $T_S$  is the soldering point temperature.  $T_S$  measured on the emitter lead at the soldering point of the pcb.

**Attention: Stresses above the max. values listed here may cause permanent damage to the device.**

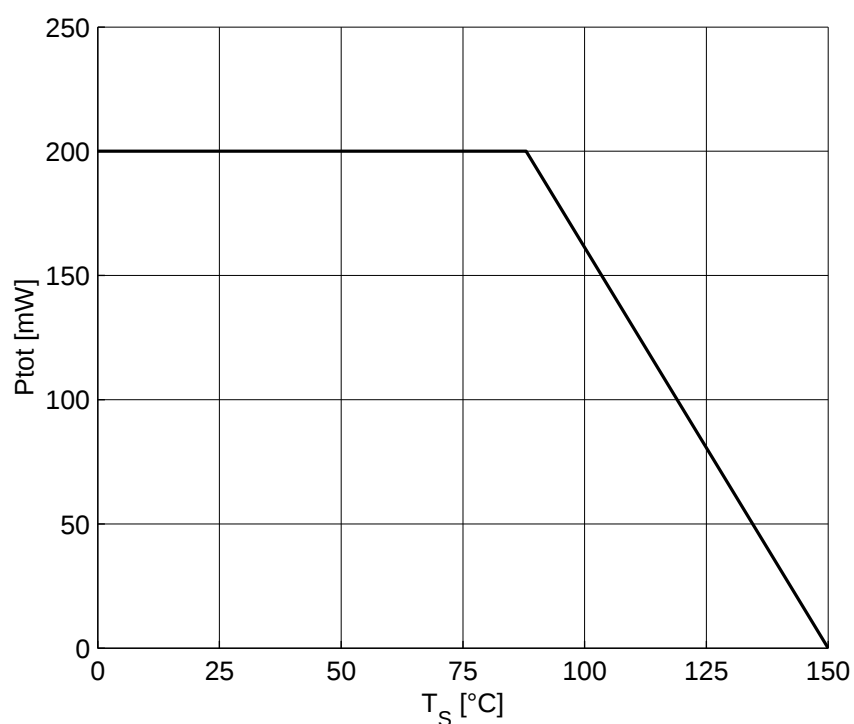
**Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the integrated circuit.**

## 4 Thermal Characteristics

**Table 4-1 Thermal Resistance**

| Parameter                                | Symbol     | Values |      |      | Unit | Note / Test Condition |
|------------------------------------------|------------|--------|------|------|------|-----------------------|
|                                          |            | Min.   | Typ. | Max. |      |                       |
| Junction - soldering point <sup>1)</sup> | $R_{thJS}$ | –      | 310  | –    | K/W  | –                     |

1) For the definition of  $R_{thJS}$  please refer to Application Note AN077 (Thermal Resistance Calculation).



**Figure 4-1 Total Power Dissipation  $P_{tot} = f(T_s)$**

## 5 Electrical Characteristics

### 5.1 DC Characteristics

**Table 5-1 DC Characteristics at  $T_A = 25\text{ °C}$**

| Parameter                           | Symbol        | Values |      |      | Unit | Note / Test Condition                                          |
|-------------------------------------|---------------|--------|------|------|------|----------------------------------------------------------------|
|                                     |               | Min.   | Typ. | Max. |      |                                                                |
| Collector emitter breakdown voltage | $V_{(BR)CEO}$ | 4.1    | 4.7  | –    | V    | $I_C = 1\text{ mA}$ , $I_B = 0$<br>Open base                   |
| Collector emitter leakage current   | $I_{CES}$     | –      | –    | 500  | nA   | $V_{CE} = 2\text{ V}$ , $V_{BE} = 0$<br>E-B short circuited    |
| Collector base leakage current      | $I_{CBO}$     | –      | –    | 500  | nA   | $V_{CB} = 2\text{ V}$ , $I_E = 0$<br>Open emitter              |
| Emitter base leakage current        | $I_{EBO}$     | –      | –    | 10   | μA   | $V_{EB} = 0.5\text{ V}$ , $I_C = 0$<br>Open collector          |
| DC current gain                     | $h_{FE}$      | 110    | 180  | 270  |      | $V_{CE} = 3\text{ V}$ , $I_C = 30\text{ mA}$<br>Pulse measured |

### 5.2 General AC Characteristics

**Table 5-2 General AC Characteristics at  $T_A = 25\text{ °C}$**

| Parameter                     | Symbol   | Values |      |      | Unit | Note / Test Condition                                                                       |
|-------------------------------|----------|--------|------|------|------|---------------------------------------------------------------------------------------------|
|                               |          | Min.   | Typ. | Max. |      |                                                                                             |
| Transition frequency          | $f_T$    | –      | 45   | –    | GHz  | $V_{CE} = 3\text{ V}$ , $I_C = 30\text{ mA}$ ,<br>$f = 1\text{ GHz}$                        |
| Collector base capacitance    | $C_{CB}$ | –      | 0.08 | –    | pF   | $V_{CB} = 3\text{ V}$ , $V_{BE} = 0\text{ V}$<br>$f = 1\text{ MHz}$<br>Emitter grounded     |
| Collector emitter capacitance | $C_{CE}$ | –      | 0.4  | –    | pF   | $V_{CE} = 3\text{ V}$ , $V_{BE} = 0\text{ V}$<br>$f = 1\text{ MHz}$<br>Base grounded        |
| Emitter base capacitance      | $C_{EB}$ | –      | 0.7  | –    | pF   | $V_{EB} = 0.4\text{ V}$ , $V_{CB} = 0\text{ V}$<br>$f = 1\text{ MHz}$<br>Collector grounded |

### 5.3 Frequency Dependent AC Characteristics

Measurement setup is a test fixture with Bias T's in a 50  $\Omega$  system,  $T_A = 25\text{ }^{\circ}\text{C}$

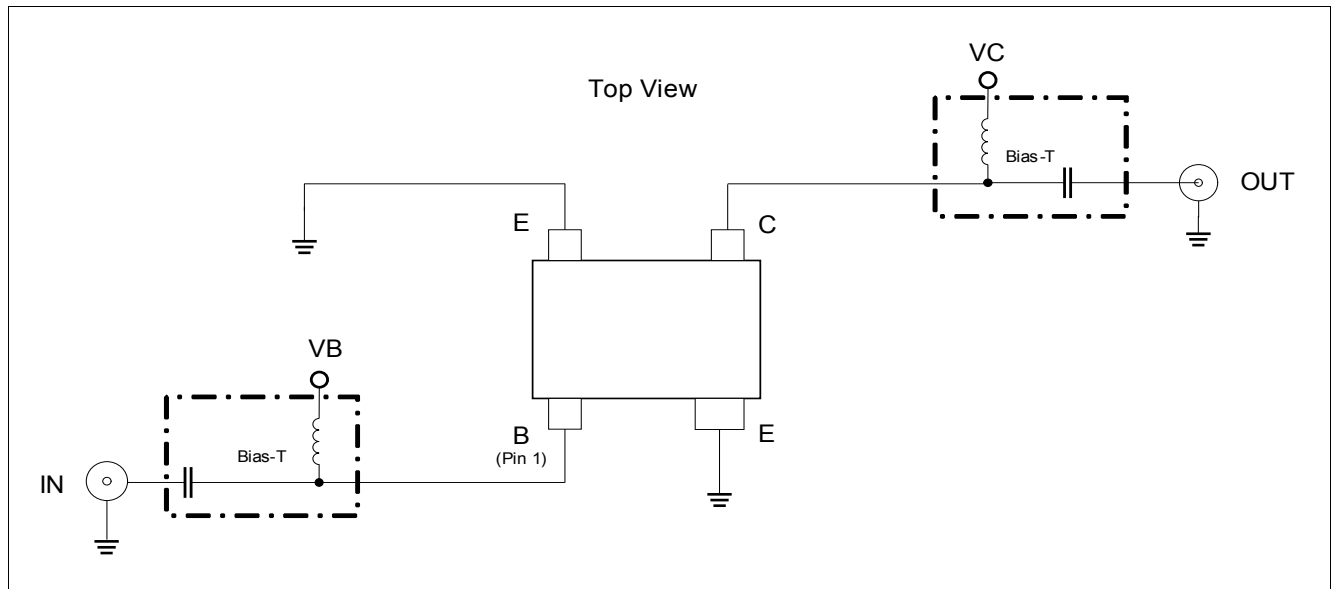


Figure 5-1 BFP640ESD Testing Circuit

Table 5-3 AC Characteristics,  $V_{CE} = 3\text{ V}$ ,  $f = 150\text{ MHz}$

| Parameter                      | Symbol     | Values |      |      | Unit | Note / Test Condition          |
|--------------------------------|------------|--------|------|------|------|--------------------------------|
|                                |            | Min.   | Typ. | Max. |      |                                |
| <b>Maximum power gain</b>      |            |        |      |      | dB   |                                |
| Low noise operation point      | $G_{ms}$   | –      | 34   | –    |      | $I_C = 6\text{ mA}$            |
| High linearity operation point | $G_{ms}$   | –      | 39.5 | –    |      | $I_C = 30\text{ mA}$           |
| <b>Transducer gain</b>         |            |        |      |      | dB   | $Z_S = Z_L = 50\text{ }\Omega$ |
| Low noise operation point      | $S_{21}$   | –      | 25   | –    |      | $I_C = 6\text{ mA}$            |
| High linearity operation point | $S_{21}$   | –      | 35   | –    |      | $I_C = 30\text{ mA}$           |
| <b>Minimum noise figure</b>    |            |        |      |      | dB   | $Z_S = Z_{opt}$                |
| Minimum noise figure           | $NF_{min}$ | –      | 0.6  | –    |      | $I_C = 6\text{ mA}$            |
| Associated gain                | $G_{ass}$  | –      | 30   | –    |      | $I_C = 6\text{ mA}$            |
| <b>Linearity</b>               |            |        |      |      | dBm  | $Z_S = Z_L = 50\text{ }\Omega$ |
| 1 dB gain compression point    | $OP_{1dB}$ | –      | 11   | –    |      | $I_C = 30\text{ mA}$           |
| 3rd order intercept point      | $OIP_3$    | –      | 25   | –    |      | $I_C = 30\text{ mA}$           |

## Electrical Characteristics

Table 5-4 AC Characteristics,  $V_{CE} = 3\text{ V}$ ,  $f = 450\text{ MHz}$ 

| Parameter                      | Symbol     | Values |      |      | Unit | Note / Test Condition    |
|--------------------------------|------------|--------|------|------|------|--------------------------|
|                                |            | Min.   | Typ. | Max. |      |                          |
| <b>Maximum power gain</b>      |            |        |      |      | dB   |                          |
| Low noise operation point      | $G_{ms}$   | –      | 29   | –    |      | $I_C = 6\text{ mA}$      |
| High linearity operation point | $G_{ms}$   | –      | 34.5 | –    |      | $I_C = 30\text{ mA}$     |
| <b>Transducer gain</b>         |            |        |      |      | dB   | $Z_S = Z_L = 50\ \Omega$ |
| Low noise operation point      | $S_{21}$   | –      | 24.5 | –    |      | $I_C = 6\text{ mA}$      |
| High linearity operation point | $S_{21}$   | –      | 32   | –    |      | $I_C = 30\text{ mA}$     |
| <b>Minimum noise figure</b>    |            |        |      |      | dB   | $Z_S = Z_{opt}$          |
| Minimum noise figure           | $NF_{min}$ | –      | 0.6  | –    |      | $I_C = 6\text{ mA}$      |
| Associated gain                | $G_{ass}$  | –      | 28.5 | –    |      | $I_C = 6\text{ mA}$      |
| <b>Linearity</b>               |            |        |      |      | dBm  | $Z_S = Z_L = 50\ \Omega$ |
| 1 dB gain compression point    | $OP_{1dB}$ | –      | 11   | –    |      | $I_C = 30\text{ mA}$     |
| 3rd order intercept point      | $OIP_3$    | –      | 25   | –    |      | $I_C = 30\text{ mA}$     |

Table 5-5 AC Characteristics,  $V_{CE} = 3\text{ V}$ ,  $f = 900\text{ MHz}$ 

| Parameter                      | Symbol     | Values |      |      | Unit | Note / Test Condition    |
|--------------------------------|------------|--------|------|------|------|--------------------------|
|                                |            | Min.   | Typ. | Max. |      |                          |
| <b>Maximum power gain</b>      |            |        |      |      | dB   |                          |
| Low noise operation point      | $G_{ms}$   | –      | 26   | –    |      | $I_C = 6\text{ mA}$      |
| High linearity operation point | $G_{ms}$   | –      | 30.5 | –    |      | $I_C = 30\text{ mA}$     |
| <b>Transducer gain</b>         |            |        |      |      | dB   | $Z_S = Z_L = 50\ \Omega$ |
| Low noise operation point      | $S_{21}$   | –      | 23.5 | –    |      | $I_C = 6\text{ mA}$      |
| High linearity operation point | $S_{21}$   | –      | 28   | –    |      | $I_C = 30\text{ mA}$     |
| <b>Minimum noise figure</b>    |            |        |      |      | dB   | $Z_S = Z_{opt}$          |
| Minimum noise figure           | $NF_{min}$ | –      | 0.6  | –    |      | $I_C = 6\text{ mA}$      |
| Associated gain                | $G_{ass}$  | –      | 26   | –    |      | $I_C = 6\text{ mA}$      |
| <b>Linearity</b>               |            |        |      |      | dBm  | $Z_S = Z_L = 50\ \Omega$ |
| 1 dB gain compression point    | $OP_{1dB}$ | –      | 11.5 | –    |      | $I_C = 30\text{ mA}$     |
| 3rd order intercept point      | $OIP_3$    | –      | 26   | –    |      | $I_C = 30\text{ mA}$     |

## Electrical Characteristics

Table 5-6 AC Characteristics,  $V_{CE} = 3\text{ V}$ ,  $f = 1.5\text{ GHz}$ 

| Parameter                      | Symbol     | Values |      |      | Unit | Note / Test Condition    |
|--------------------------------|------------|--------|------|------|------|--------------------------|
|                                |            | Min.   | Typ. | Max. |      |                          |
| <b>Maximum power gain</b>      |            |        |      |      | dB   |                          |
| Low noise operation point      | $G_{ms}$   | –      | 23.5 | –    |      | $I_C = 6\text{ mA}$      |
| High linearity operation point | $G_{ms}$   | –      | 26.5 | –    |      | $I_C = 30\text{ mA}$     |
| <b>Transducer gain</b>         |            |        |      |      | dB   | $Z_S = Z_L = 50\ \Omega$ |
| Low noise operation point      | $S_{21}$   | –      | 21   | –    |      | $I_C = 6\text{ mA}$      |
| High linearity operation point | $S_{21}$   | –      | 24   | –    |      | $I_C = 30\text{ mA}$     |
| <b>Minimum noise figure</b>    |            |        |      |      | dB   | $Z_S = Z_{opt}$          |
| Minimum noise figure           | $NF_{min}$ | –      | 0.65 | –    |      | $I_C = 6\text{ mA}$      |
| Associated gain                | $G_{ass}$  | –      | 23.5 | –    |      | $I_C = 6\text{ mA}$      |
| <b>Linearity</b>               |            |        |      |      | dBm  | $Z_S = Z_L = 50\ \Omega$ |
| 1 dB gain compression point    | $OP_{1dB}$ | –      | 12   | –    |      | $I_C = 30\text{ mA}$     |
| 3rd order intercept point      | $OIP_3$    | –      | 26.5 | –    |      | $I_C = 30\text{ mA}$     |

Table 5-7 AC Characteristics,  $V_{CE} = 3\text{ V}$ ,  $f = 1.9\text{ GHz}$ 

| Parameter                      | Symbol     | Values |      |      | Unit | Note / Test Condition    |
|--------------------------------|------------|--------|------|------|------|--------------------------|
|                                |            | Min.   | Typ. | Max. |      |                          |
| <b>Maximum power gain</b>      |            |        |      |      | dB   |                          |
| Low noise operation point      | $G_{ms}$   | –      | 22.5 | –    |      | $I_C = 6\text{ mA}$      |
| High linearity operation point | $G_{ms}$   | –      | 25   | –    |      | $I_C = 30\text{ mA}$     |
| <b>Transducer gain</b>         |            |        |      |      | dB   | $Z_S = Z_L = 50\ \Omega$ |
| Low noise operation point      | $S_{21}$   | –      | 19.5 | –    |      | $I_C = 6\text{ mA}$      |
| High linearity operation point | $S_{21}$   | –      | 22   | –    |      | $I_C = 30\text{ mA}$     |
| <b>Minimum noise figure</b>    |            |        |      |      | dB   | $Z_S = Z_{opt}$          |
| Minimum noise figure           | $NF_{min}$ | –      | 0.65 | –    |      | $I_C = 6\text{ mA}$      |
| Associated gain                | $G_{ass}$  | –      | 22   | –    |      | $I_C = 6\text{ mA}$      |
| <b>Linearity</b>               |            |        |      |      | dBm  | $Z_S = Z_L = 50\ \Omega$ |
| 1 dB gain compression point    | $OP_{1dB}$ | –      | 12   | –    |      | $I_C = 30\text{ mA}$     |
| 3rd order intercept point      | $OIP_3$    | –      | 27   | –    |      | $I_C = 30\text{ mA}$     |

## Electrical Characteristics

Table 5-8 AC Characteristics,  $V_{CE} = 3\text{ V}$ ,  $f = 2.4\text{ GHz}$ 

| Parameter                      | Symbol     | Values |      |      | Unit | Note / Test Condition    |
|--------------------------------|------------|--------|------|------|------|--------------------------|
|                                |            | Min.   | Typ. | Max. |      |                          |
| <b>Maximum power gain</b>      |            |        |      |      | dB   |                          |
| Low noise operation point      | $G_{ms}$   | –      | 21   | –    |      | $I_C = 6\text{ mA}$      |
| High linearity operation point | $G_{ms}$   | –      | 23   | –    |      | $I_C = 30\text{ mA}$     |
| <b>Transducer gain</b>         |            |        |      |      | dB   | $Z_S = Z_L = 50\ \Omega$ |
| Low noise operation point      | $S_{21}$   | –      | 18   | –    |      | $I_C = 6\text{ mA}$      |
| High linearity operation point | $S_{21}$   | –      | 20   | –    |      | $I_C = 30\text{ mA}$     |
| <b>Minimum noise figure</b>    |            |        |      |      | dB   | $Z_S = Z_{opt}$          |
| Minimum noise figure           | $NF_{min}$ | –      | 0.7  | –    |      | $I_C = 6\text{ mA}$      |
| Associated gain                | $G_{ass}$  | –      | 20   | –    |      | $I_C = 6\text{ mA}$      |
| <b>Linearity</b>               |            |        |      |      | dBm  | $Z_S = Z_L = 50\ \Omega$ |
| 1 dB gain compression point    | $OP_{1dB}$ | –      | 12.5 | –    |      | $I_C = 30\text{ mA}$     |
| 3rd order intercept point      | $OIP_3$    | –      | 27   | –    |      | $I_C = 30\text{ mA}$     |

Table 5-9 AC Characteristics,  $V_{CE} = 3\text{ V}$ ,  $f = 3.5\text{ GHz}$ 

| Parameter                      | Symbol     | Values |      |      | Unit | Note / Test Condition    |
|--------------------------------|------------|--------|------|------|------|--------------------------|
|                                |            | Min.   | Typ. | Max. |      |                          |
| <b>Maximum power gain</b>      |            |        |      |      | dB   |                          |
| Low noise operation point      | $G_{ma}$   | –      | 19   | –    |      | $I_C = 6\text{ mA}$      |
| High linearity operation point | $G_{ms}$   | –      | 19   | –    |      | $I_C = 30\text{ mA}$     |
| <b>Transducer gain</b>         |            |        |      |      | dB   | $Z_S = Z_L = 50\ \Omega$ |
| Low noise operation point      | $S_{21}$   | –      | 15   | –    |      | $I_C = 6\text{ mA}$      |
| High linearity operation point | $S_{21}$   | –      | 17   | –    |      | $I_C = 30\text{ mA}$     |
| <b>Minimum noise figure</b>    |            |        |      |      | dB   | $Z_S = Z_{opt}$          |
| Minimum noise figure           | $NF_{min}$ | –      | 0.8  | –    |      | $I_C = 6\text{ mA}$      |
| Associated gain                | $G_{ass}$  | –      | 16   | –    |      | $I_C = 6\text{ mA}$      |
| <b>Linearity</b>               |            |        |      |      | dBm  | $Z_S = Z_L = 50\ \Omega$ |
| 1 dB gain compression point    | $OP_{1dB}$ | –      | 12.5 | –    |      | $I_C = 30\text{ mA}$     |
| 3rd order intercept point      | $OIP_3$    | –      | 26.5 | –    |      | $I_C = 30\text{ mA}$     |

## Electrical Characteristics

Table 5-10 AC Characteristics,  $V_{CE} = 3\text{ V}$ ,  $f = 5.5\text{ GHz}$ 

| Parameter                      | Symbol     | Values |      |      | Unit | Note / Test Condition    |
|--------------------------------|------------|--------|------|------|------|--------------------------|
|                                |            | Min.   | Typ. | Max. |      |                          |
| <b>Maximum power gain</b>      |            |        |      |      | dB   |                          |
| Low noise operation point      | $G_{ma}$   | –      | 14   | –    |      | $I_C = 6\text{ mA}$      |
| High linearity operation point | $G_{ma}$   | –      | 14.5 | –    |      | $I_C = 30\text{ mA}$     |
| <b>Transducer gain</b>         |            |        |      |      | dB   | $Z_S = Z_L = 50\ \Omega$ |
| Low noise operation point      | $S_{21}$   | –      | 11   | –    |      | $I_C = 6\text{ mA}$      |
| High linearity operation point | $S_{21}$   | –      | 12.5 | –    |      | $I_C = 30\text{ mA}$     |
| <b>Minimum noise figure</b>    |            |        |      |      | dB   | $Z_S = Z_{opt}$          |
| Minimum noise figure           | $NF_{min}$ | –      | 1.05 | –    |      | $I_C = 6\text{ mA}$      |
| Associated gain                | $G_{ass}$  | –      | 11.5 | –    |      | $I_C = 6\text{ mA}$      |
| <b>Linearity</b>               |            |        |      |      | dBm  | $Z_S = Z_L = 50\ \Omega$ |
| 1 dB gain compression point    | $OP_{1dB}$ | –      | 12.5 | –    |      | $I_C = 30\text{ mA}$     |
| 3rd order intercept point      | $OIP_3$    | –      | 26   | –    |      | $I_C = 30\text{ mA}$     |

Table 5-11 AC Characteristics,  $V_{CE} = 3\text{ V}$ ,  $f = 10\text{ GHz}$ 

| Parameter                      | Symbol     | Values |      |      | Unit | Note / Test Condition    |
|--------------------------------|------------|--------|------|------|------|--------------------------|
|                                |            | Min.   | Typ. | Max. |      |                          |
| <b>Maximum power gain</b>      |            |        |      |      | dB   |                          |
| Low noise operation point      | $G_{ms}$   | –      | 10   | –    |      | $I_C = 6\text{ mA}$      |
| High linearity operation point | $G_{ms}$   | –      | 10.5 | –    |      | $I_C = 30\text{ mA}$     |
| <b>Transducer gain</b>         |            |        |      |      | dB   | $Z_S = Z_L = 50\ \Omega$ |
| Low noise operation point      | $S_{21}$   | –      | 4.5  | –    |      | $I_C = 6\text{ mA}$      |
| High linearity operation point | $S_{21}$   | –      | 6    | –    |      | $I_C = 30\text{ mA}$     |
| <b>Minimum noise figure</b>    |            |        |      |      | dB   | $Z_S = Z_{opt}$          |
| Minimum noise figure           | $NF_{min}$ | –      | 2    | –    |      | $I_C = 6\text{ mA}$      |
| Associated gain                | $G_{ass}$  | –      | 7    | –    |      | $I_C = 6\text{ mA}$      |
| <b>Linearity</b>               |            |        |      |      | dBm  | $Z_S = Z_L = 50\ \Omega$ |
| 1 dB gain compression point    | $OP_{1dB}$ | –      | 11   | –    |      | $I_C = 30\text{ mA}$     |
| 3rd order intercept point      | $OIP_3$    | –      | 25.5 | –    |      | $I_C = 30\text{ mA}$     |

## Notes

- $G_{ms} = |S_{21} / S_{12}|$  for  $k < 1$ ;  $G_{ma} = |S_{21} / S_{12}| (k - (k^2 - 1)^{1/2})$  for  $k > 1$ .
- In order to get the  $NF_{min}$  values stated in this chapter the test fixture losses have been subtracted from all measured result.
- $OIP_3$  value depends on termination of all intermodulation frequency components. Termination used for this measurement is  $50\ \Omega$  from  $0.2\text{ MHz}$  to  $12\text{ GHz}$ .

## 5.4 Characteristic DC Diagrams

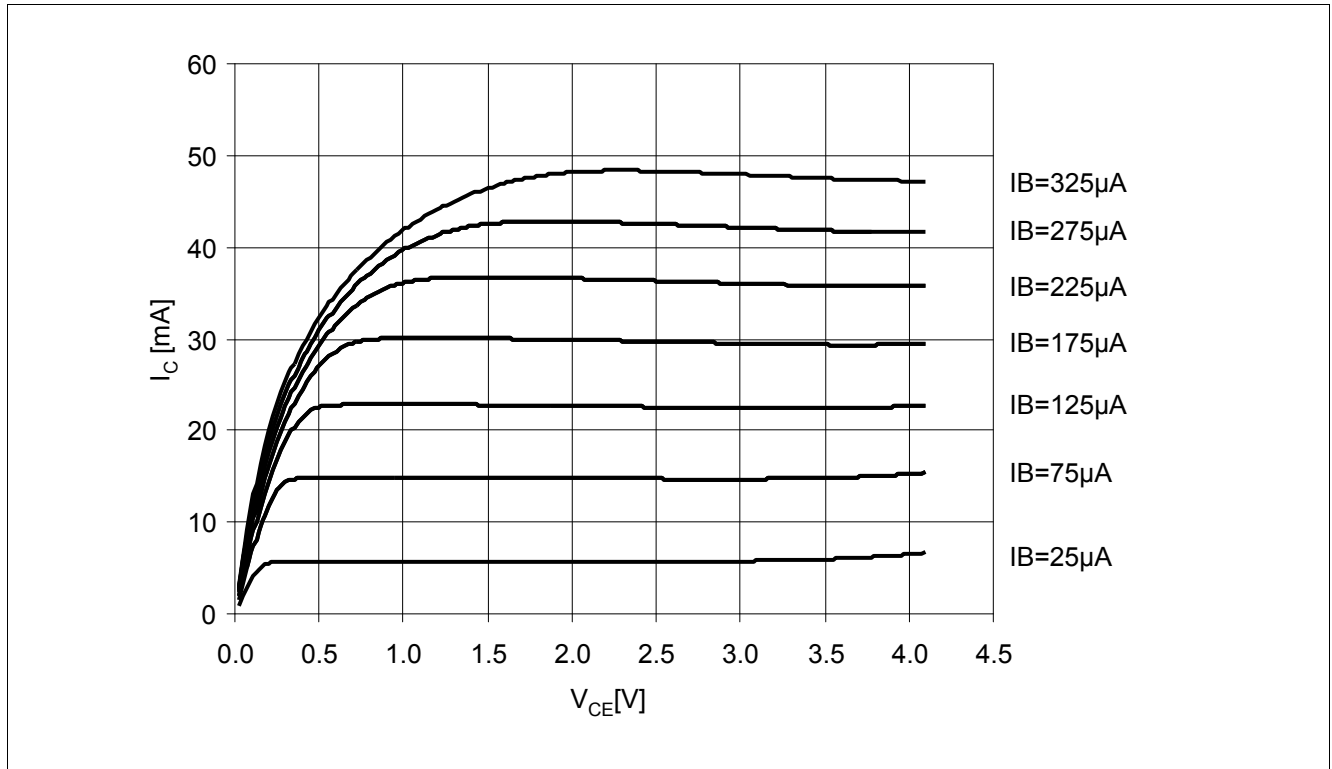


Figure 5-2 Collector Current vs. Collector Emitter Voltage  $I_C = f(V_{CE})$ ,  $I_B = \text{Parameter in } \mu\text{A}$

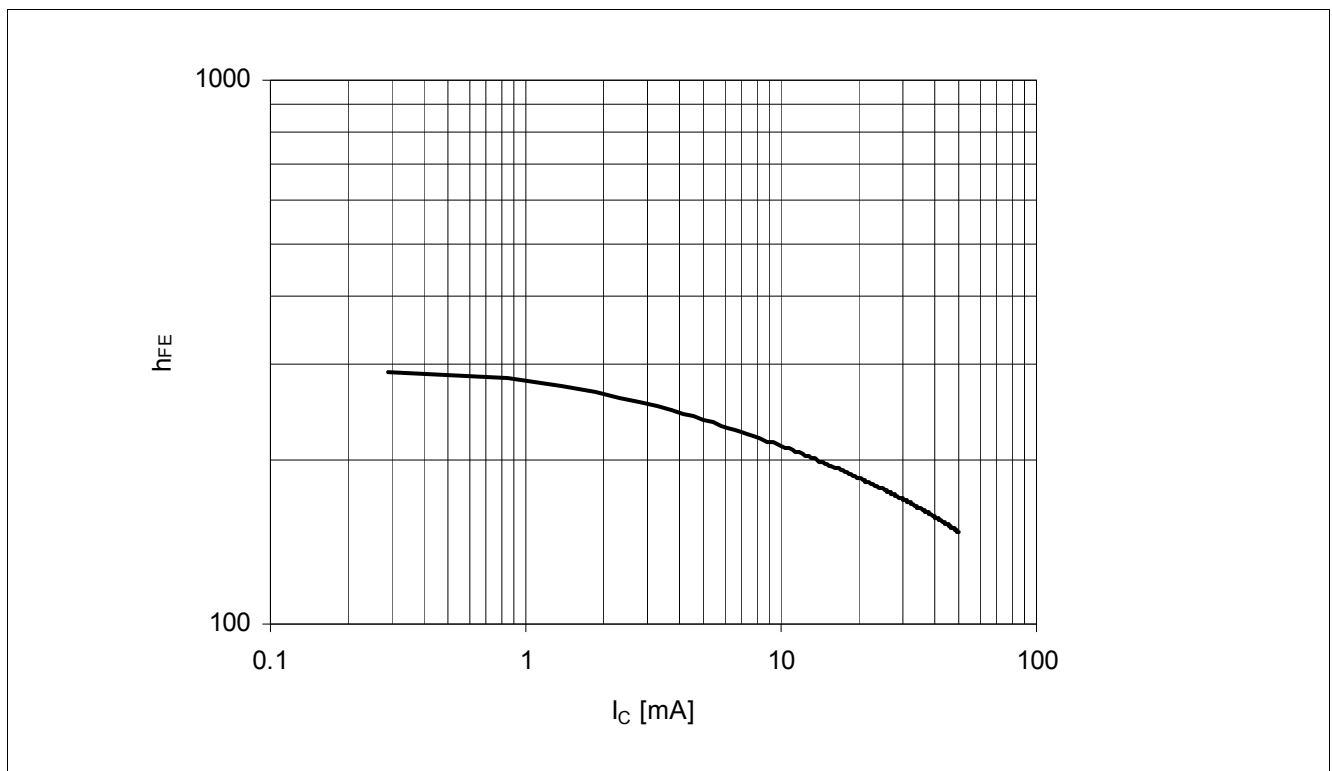


Figure 5-3 DC Current Gain  $h_{FE} = f(I_C)$ ,  $V_{CE} = 3 \text{ V}$

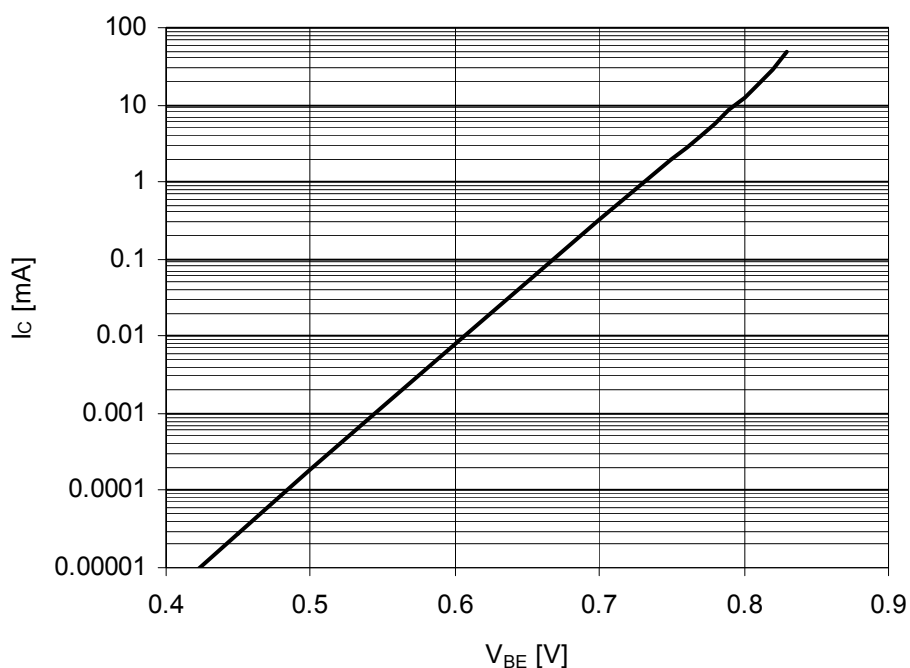


Figure 5-4 Collector Current vs. Base Emitter Voltage  $I_C = f(V_{BE})$ ,  $V_{CE} = 2\text{ V}$

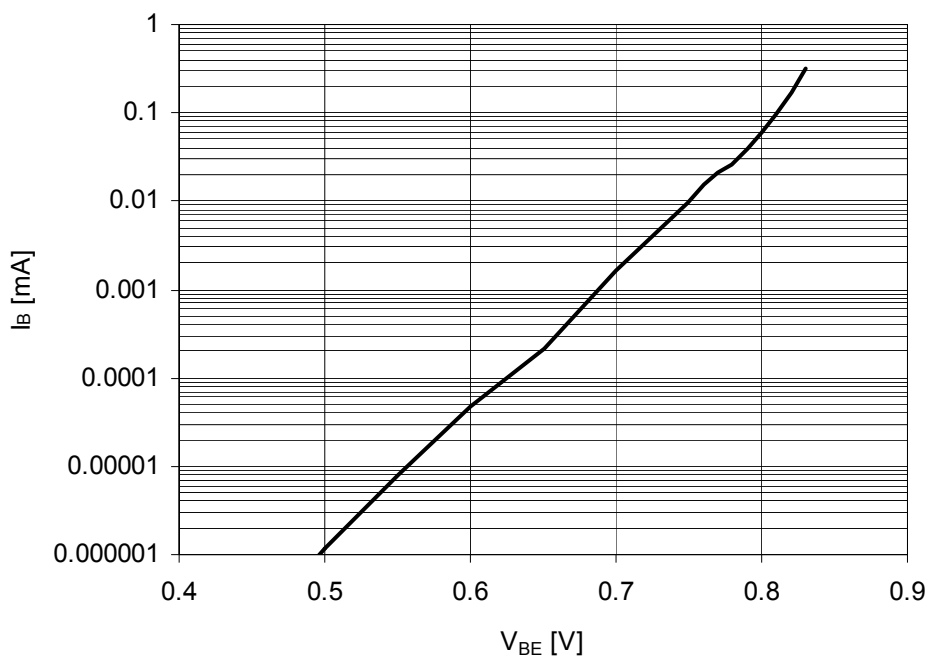


Figure 5-5 Base Current vs. Base Emitter Forward Voltage  $I_B = f(V_{BE})$ ,  $V_{CE} = 2\text{ V}$

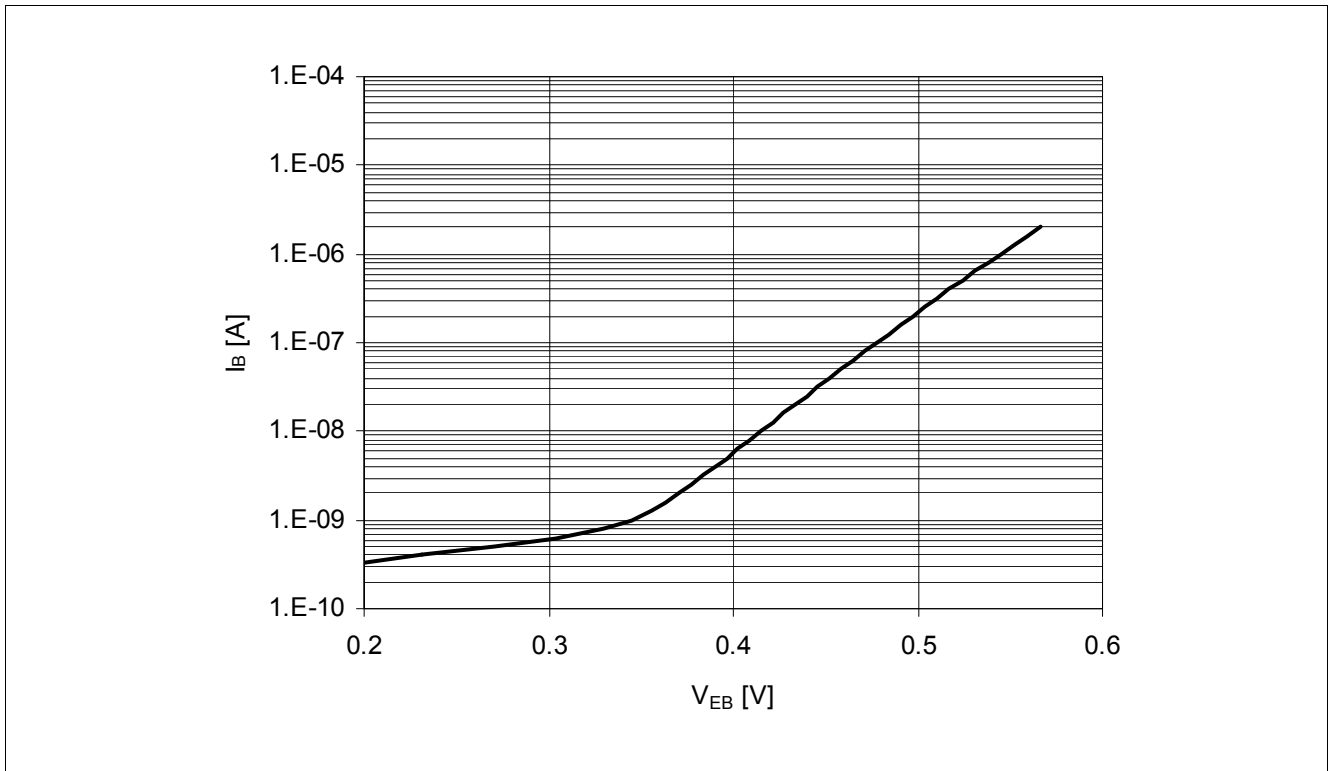


Figure 5-6 Base Current vs. Base Emitter Reverse Voltage  $I_B = f(V_{EB})$ ,  $V_{CE} = 2$  V

## 5.5 Characteristic AC Diagrams

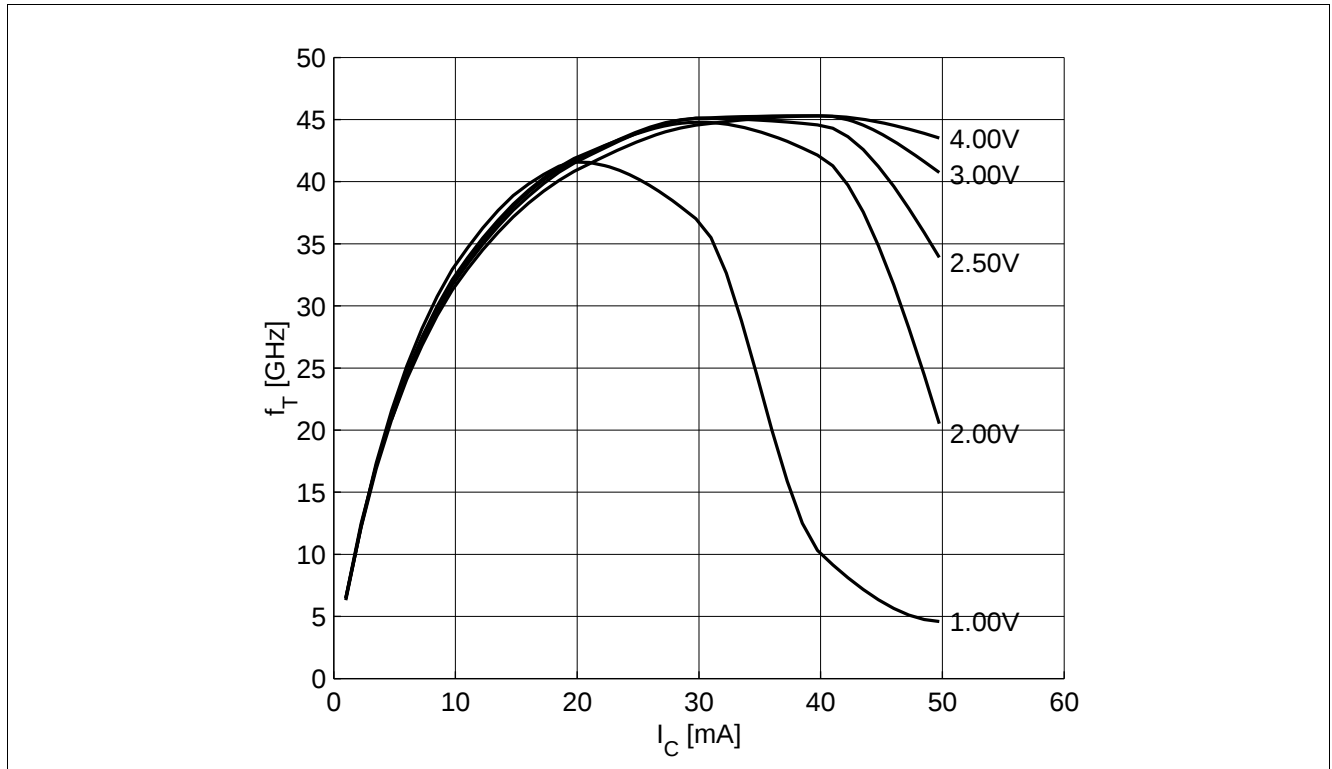


Figure 5-7 Transition Frequency  $f_T = f(I_C)$ ,  $f = 1 \text{ GHz}$ ,  $V_{CE} = \text{Parameter in V}$

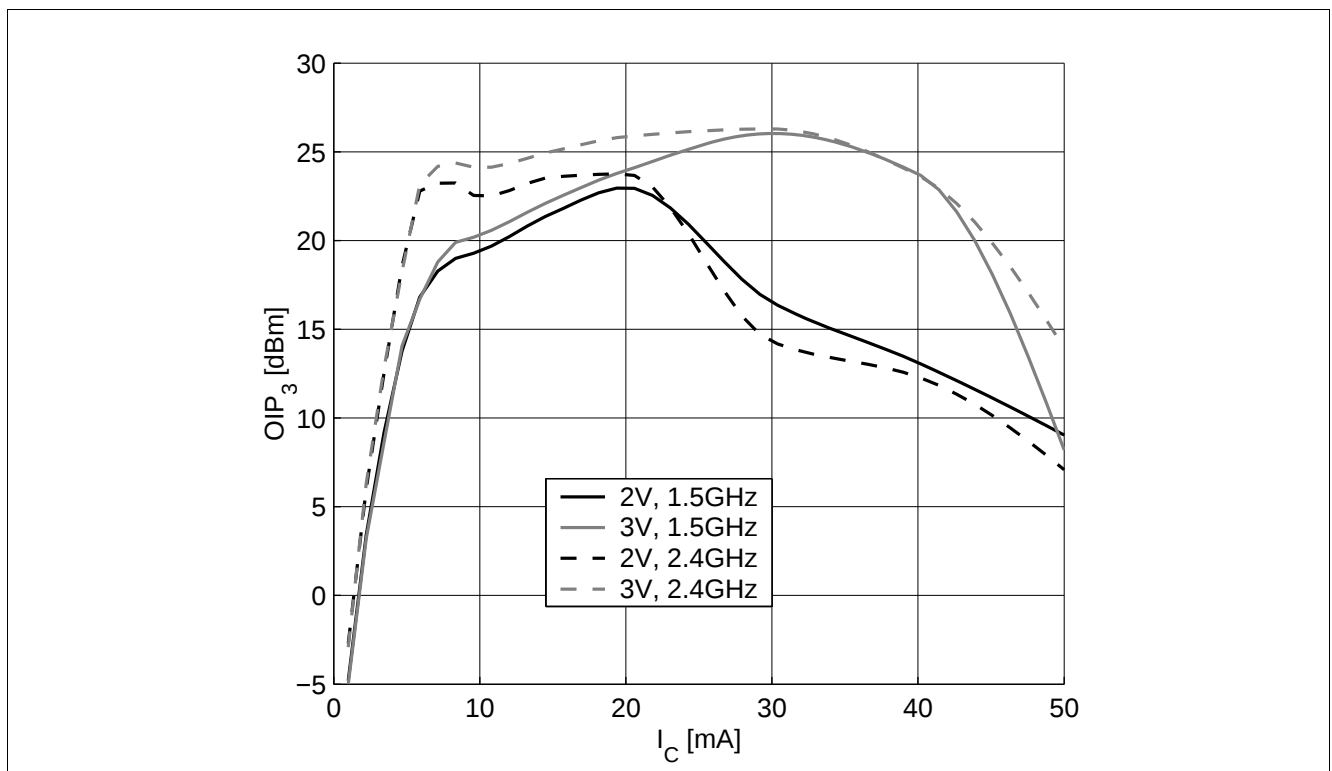


Figure 5-8 3rd Order Intercept Point  $OIP_3 = f(I_C)$ ,  $Z_S = Z_L = 50 \Omega$ ,  $V_{CE}$ ,  $f = \text{Parameters}$

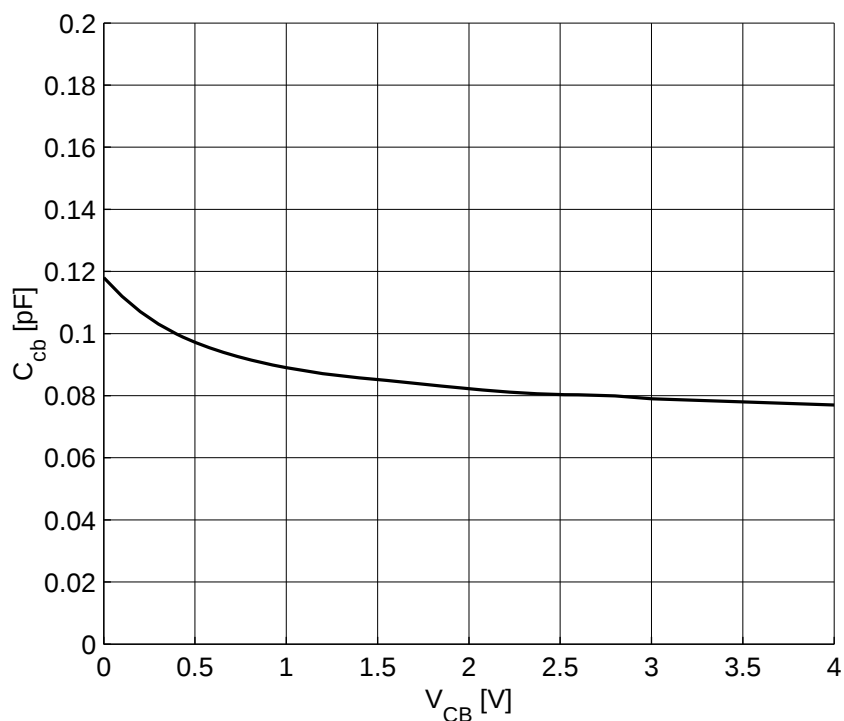


Figure 5-9 Collector Base Capacitance  $C_{CB} = f(V_{CB})$ ,  $f = 1$  MHz

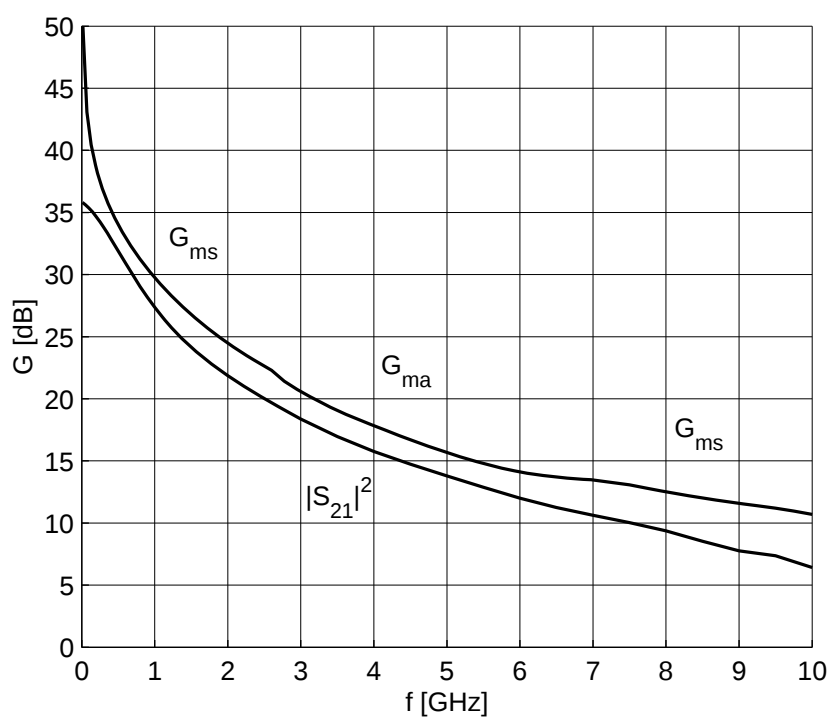


Figure 5-10 Gain  $G_{ma}$ ,  $G_{ms}$ ,  $|S_{21}|^2 = f(f)$ ,  $V_{CE} = 3$  V,  $I_C = 30$  mA

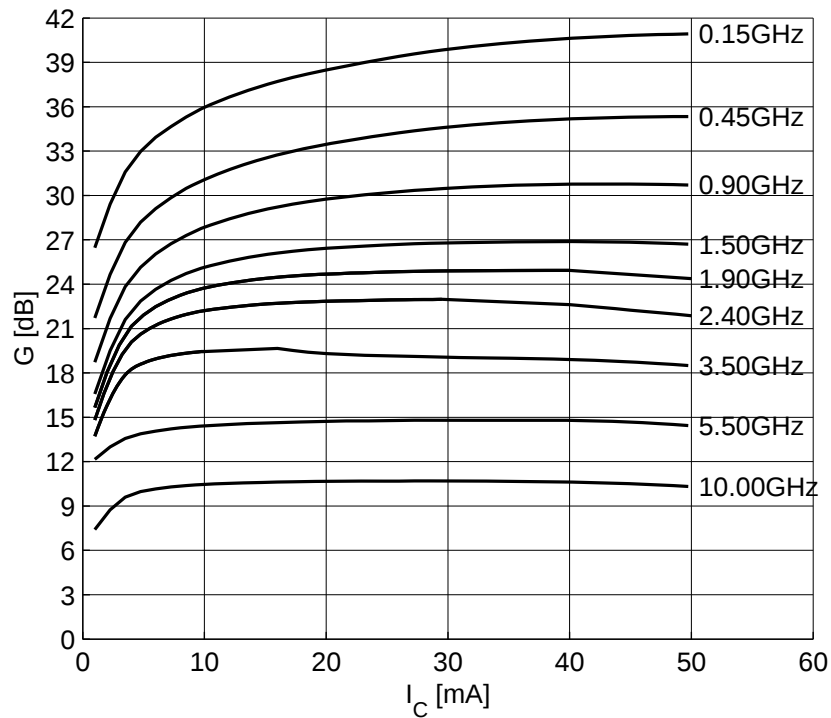


Figure 5-11 Maximum Power Gain  $G_{\max} = f(I_C)$ ,  $V_{CE} = 3\text{ V}$ ,  $f = \text{Parameter in GHz}$

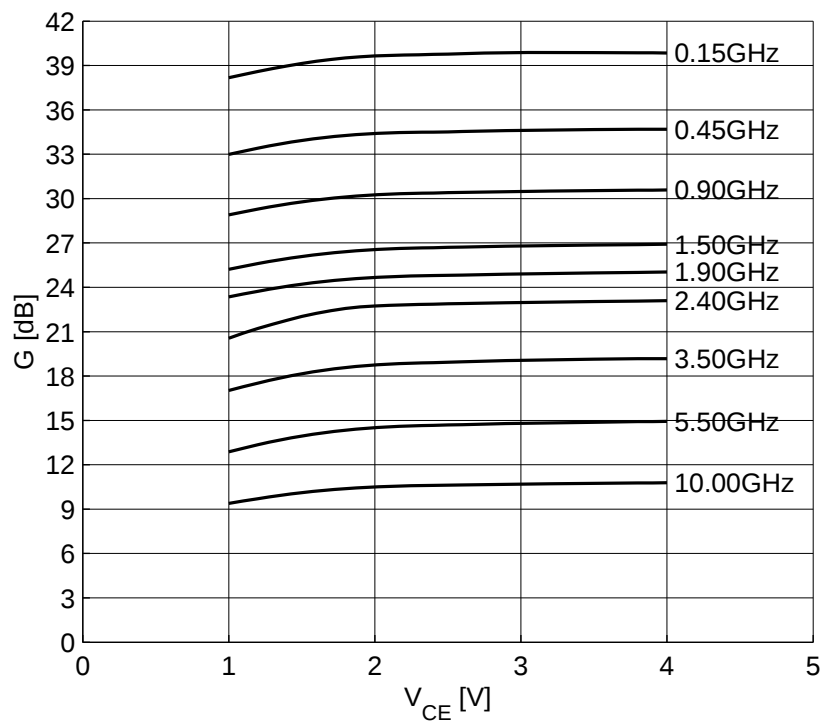


Figure 5-12 Maximum Power Gain  $G_{\max} = f(V_{CE})$ ,  $I_C = 30\text{ mA}$ ,  $f = \text{Parameter in GHz}$

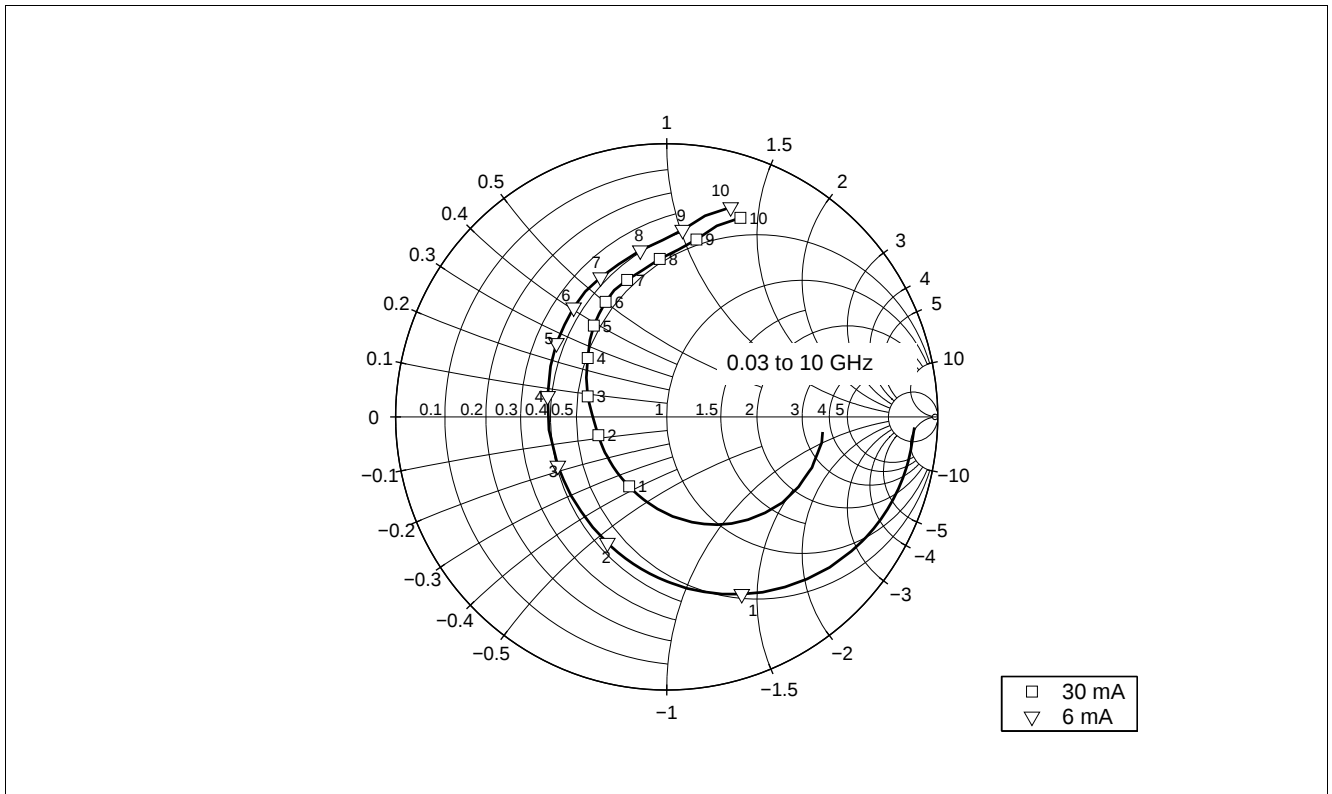


Figure 5-13 Input Matching  $S_{11} = f(f)$ ,  $V_{CE} = 3\text{ V}$ ,  $I_C = 6 / 30\text{ mA}$

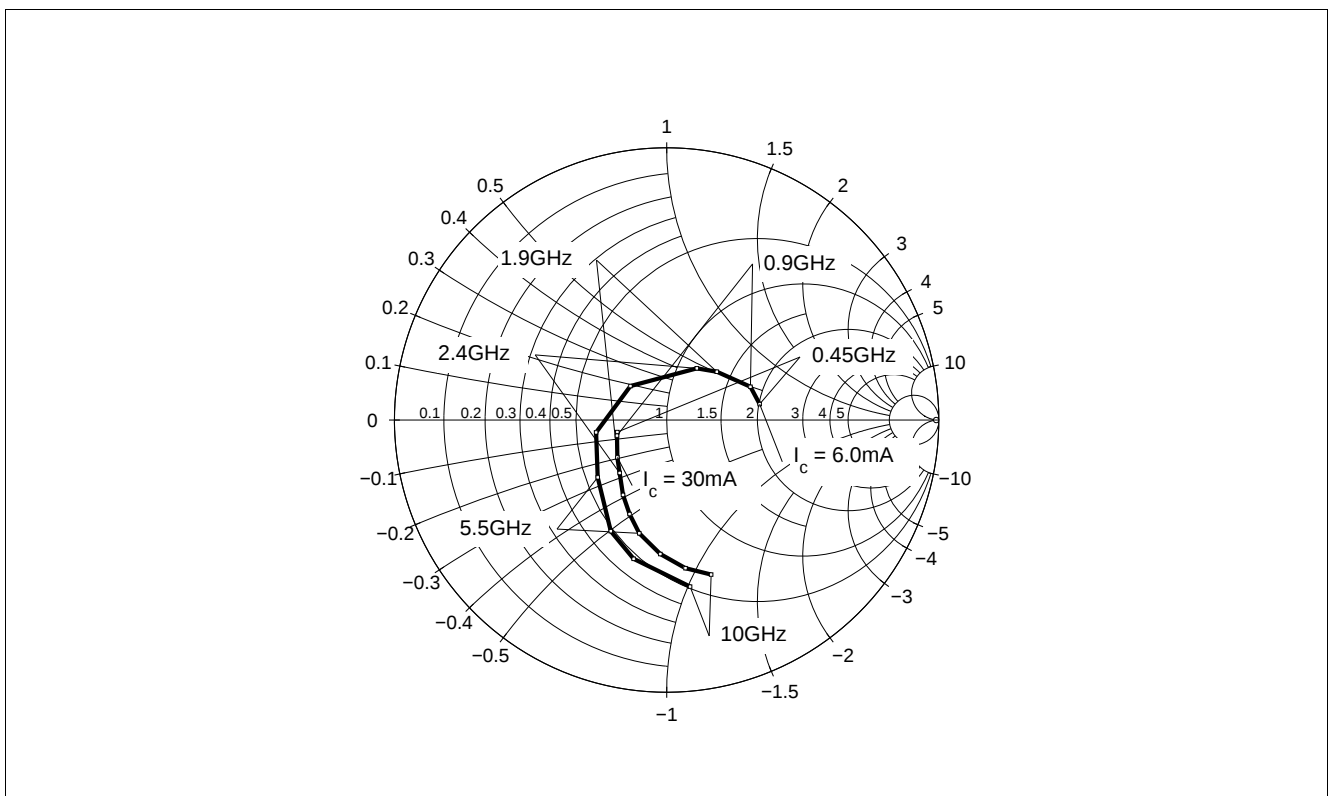


Figure 5-14 Source Impedance for Minimum Noise Figure  $Z_{opt} = f(f)$ ,  $V_{CE} = 3\text{ V}$ ,  $I_C = 6 / 30\text{ mA}$

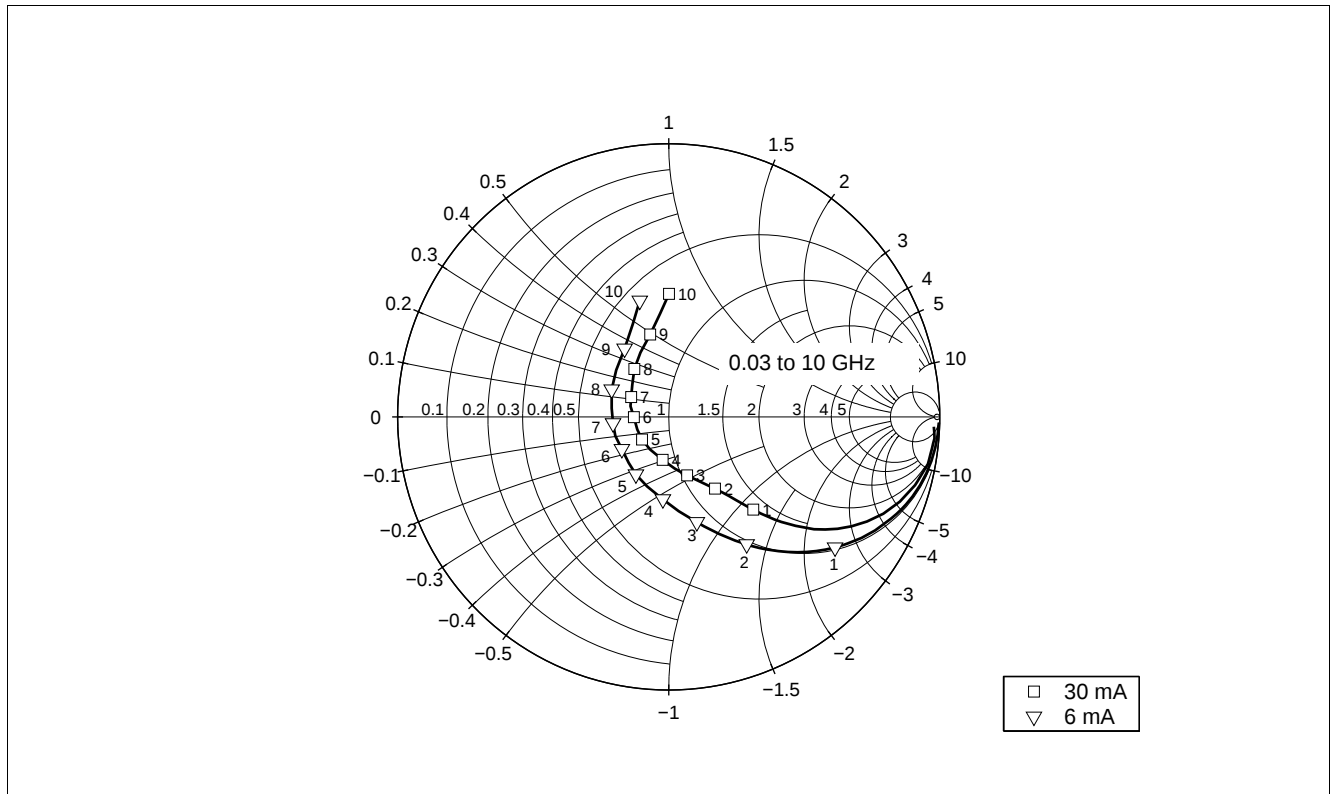


Figure 5-15 Output Matching  $S_{22} = f(f)$ ,  $V_{CE} = 3 \text{ V}$ ,  $I_C = 6 / 30 \text{ mA}$

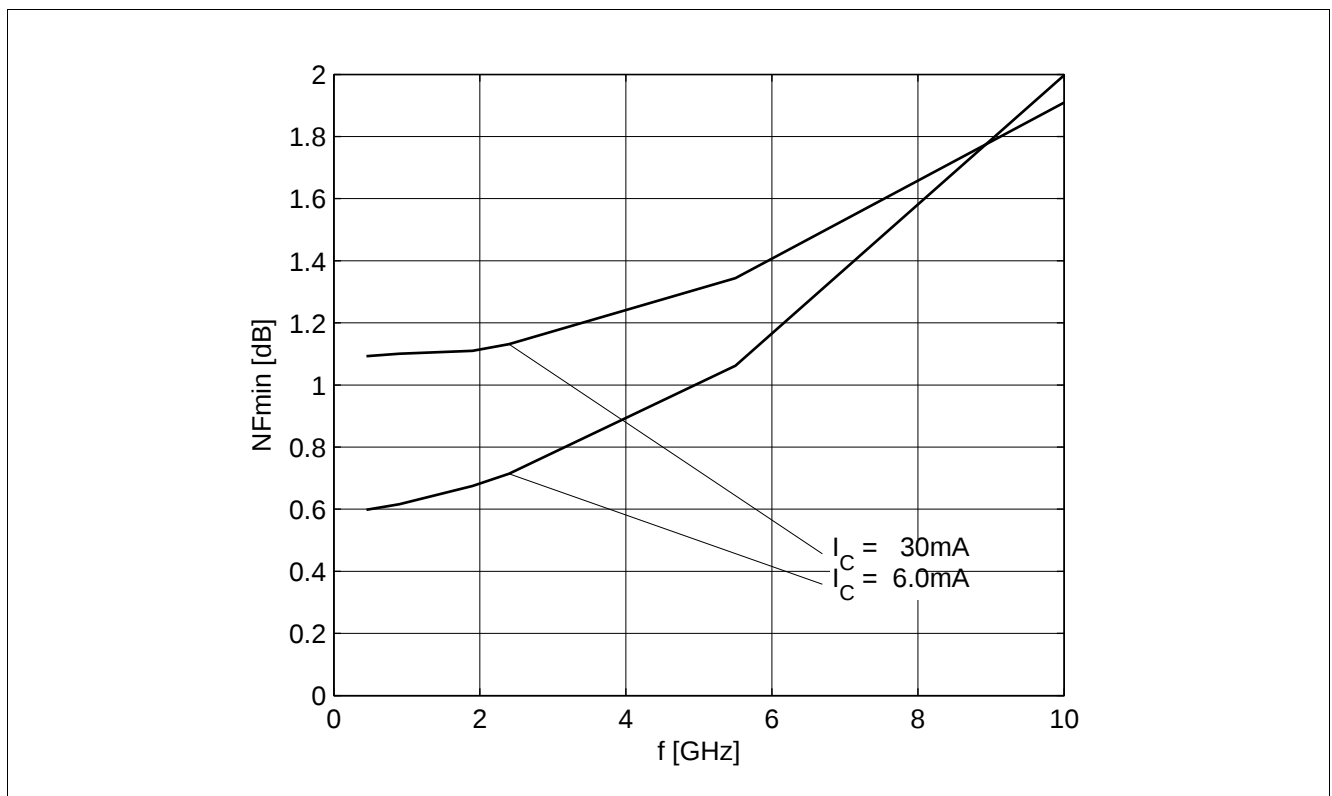


Figure 5-16 Noise Figure  $NF_{min} = f(f)$ ,  $V_{CE} = 3 \text{ V}$ ,  $I_C = 6 / 30 \text{ mA}$ ,  $Z_S = Z_{opt}$

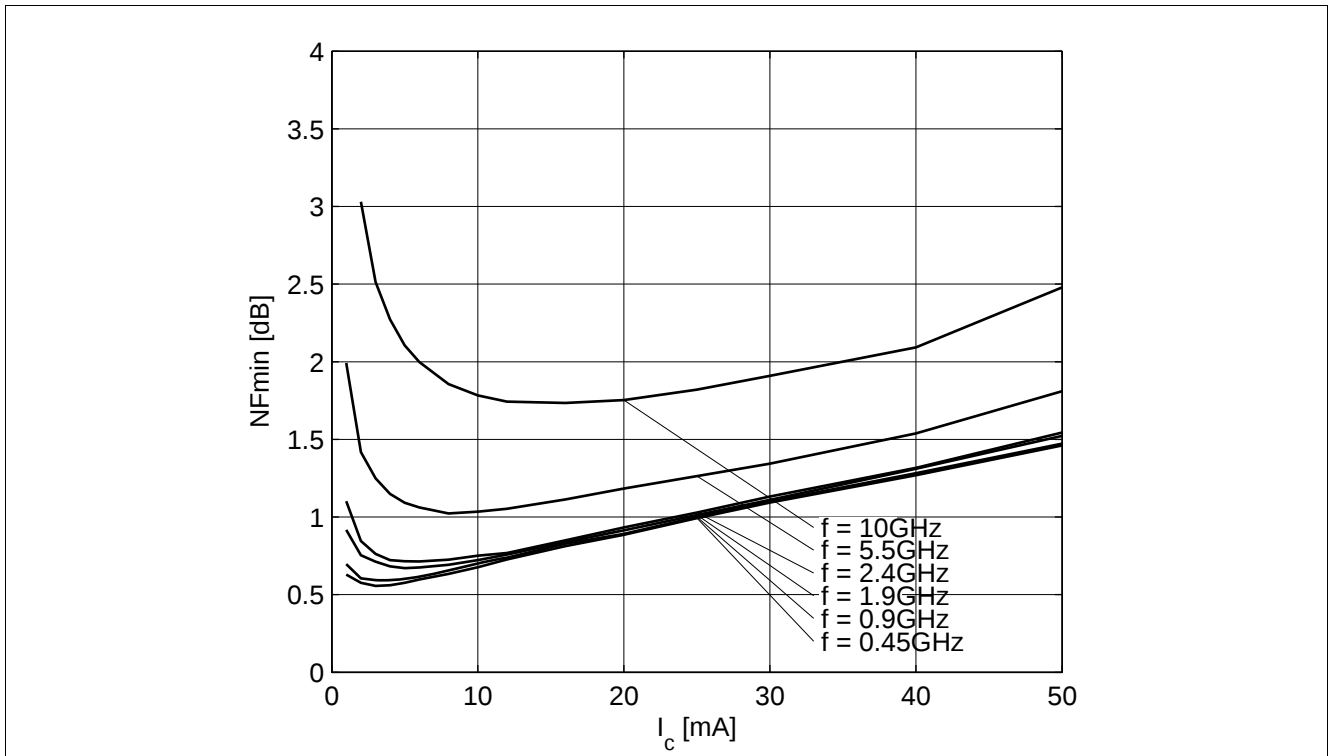


Figure 5-17 Noise Figure  $NF_{min} = f(I_c)$ ,  $V_{CE} = 3\text{ V}$ ,  $Z_S = Z_{opt}$ ,  $f$  = Parameter in GHz

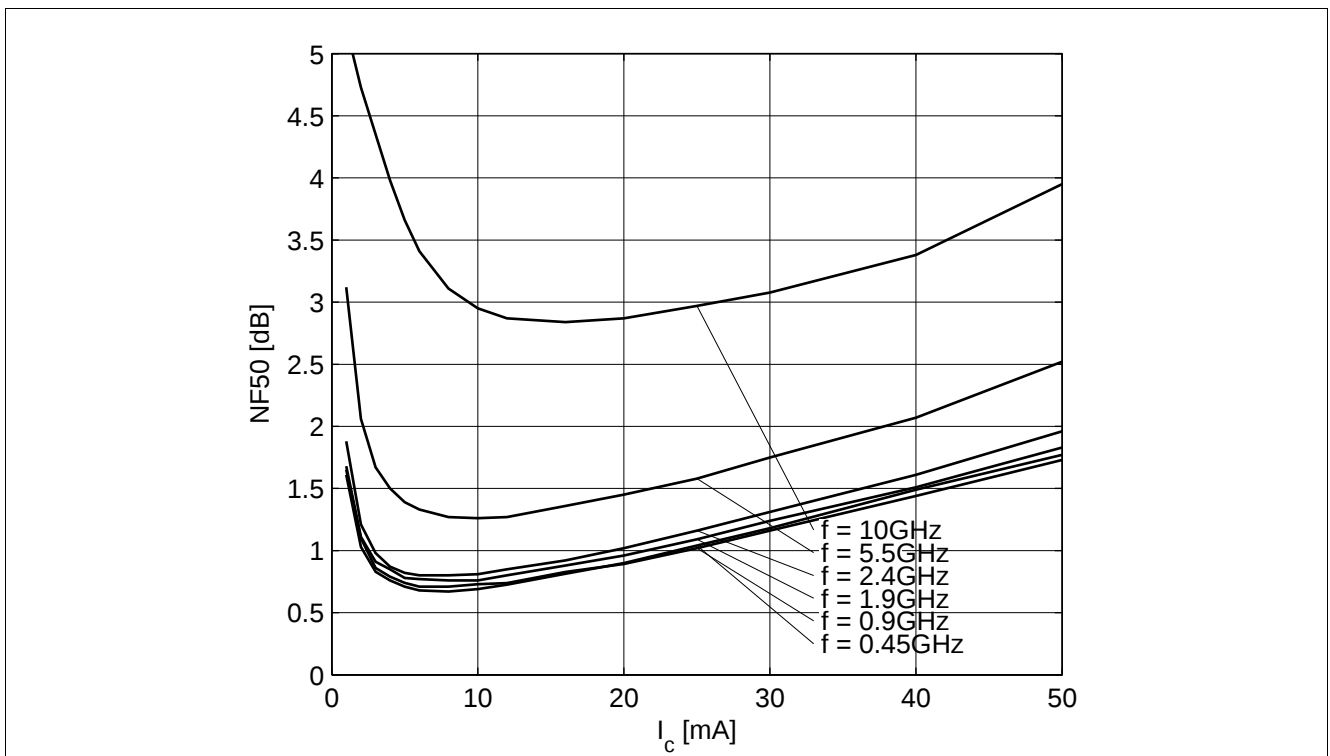


Figure 5-18 Noise Figure  $NF_{50} = f(I_c)$ ,  $V_{CE} = 3\text{ V}$ ,  $Z_S = 50\ \Omega$ ,  $f$  = Parameter in GHz

*Note: The curves shown in this chapter have been generated using typical devices but shall not be considered as a guarantee that all devices have identical characteristic curves.  $T_A = 25^\circ\text{C}$ .*

## 6 Simulation Data

For the SPICE Gummel Poon (GP) model as well as for the S-parameters (including noise parameters) please refer to our internet website: [www.infineon.com/rf.models](http://www.infineon.com/rf.models). Please consult our website and download the latest versions before actually starting your design.

You find the BFP640ESD SPICE GP model in the internet in MWO- and ADS-format, which you can import into these circuit simulation tools very quickly and conveniently. The model already contains the package parasitics and is ready to use for DC- and high frequency simulations. The terminals of the model circuit correspond to the pin configuration of the device.

The model parameters have been extracted and verified up to 10 GHz using typical devices. The BFP640ESD SPICE GP model reflects the typical DC- and RF-performance within the limitations which are given by the SPICE GP model itself. Besides the DC characteristics all S-parameters in magnitude and phase, as well as noise figure (including optimum source impedance, equivalent noise resistance and flicker noise) and intermodulation have been extracted.

## 7 Package Information SOT343

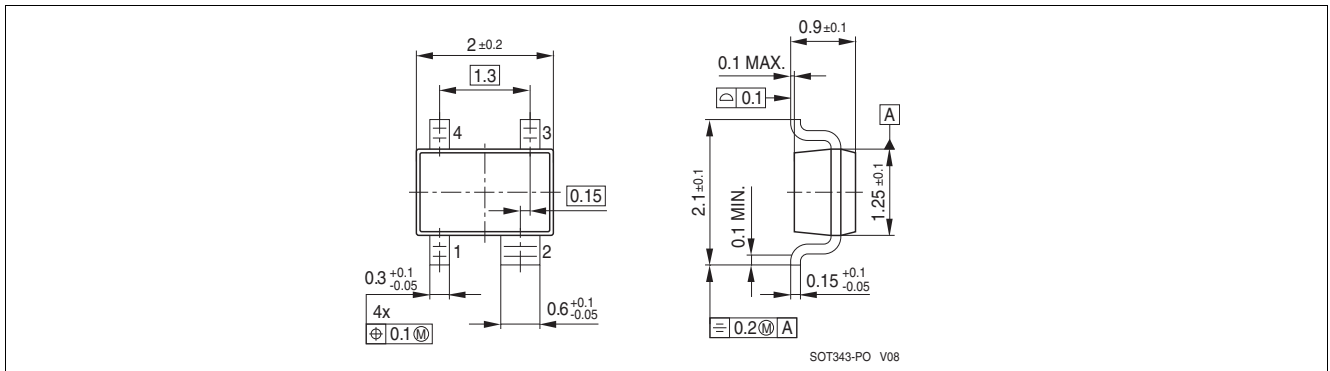


Figure 7-1 Package Outline

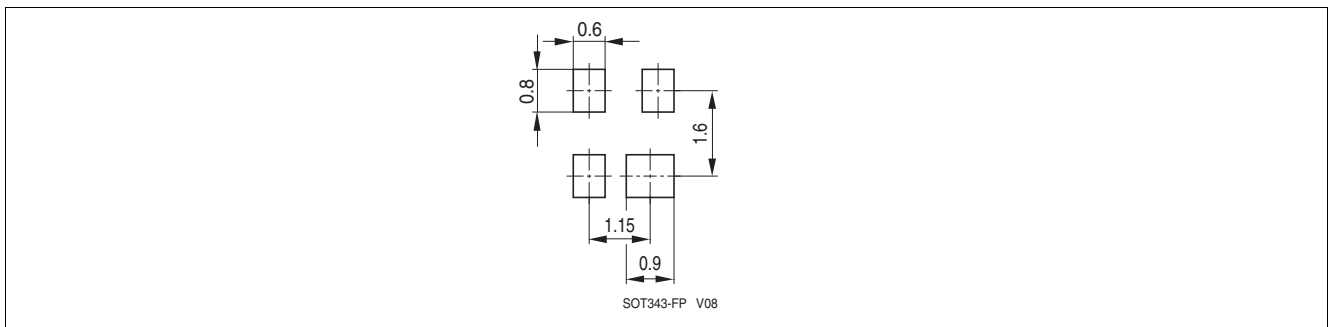


Figure 7-2 Package Footprint

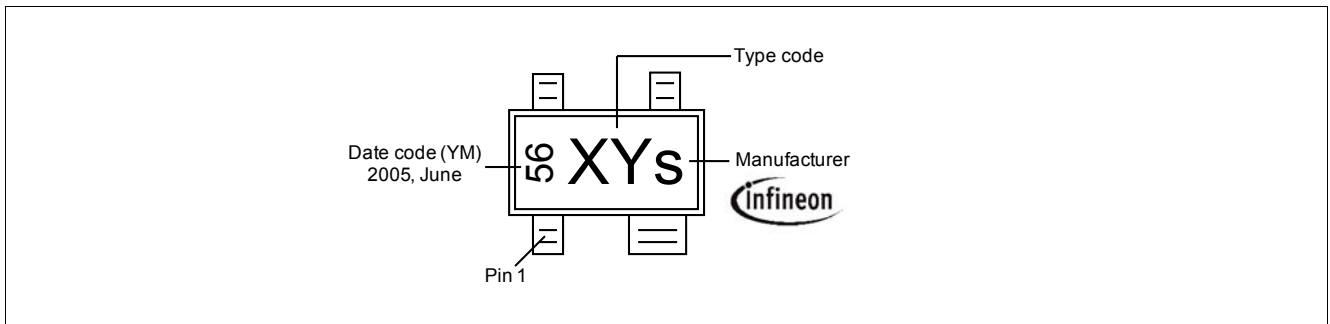


Figure 7-3 Marking Description (Marking BFP640ESD: T4s)

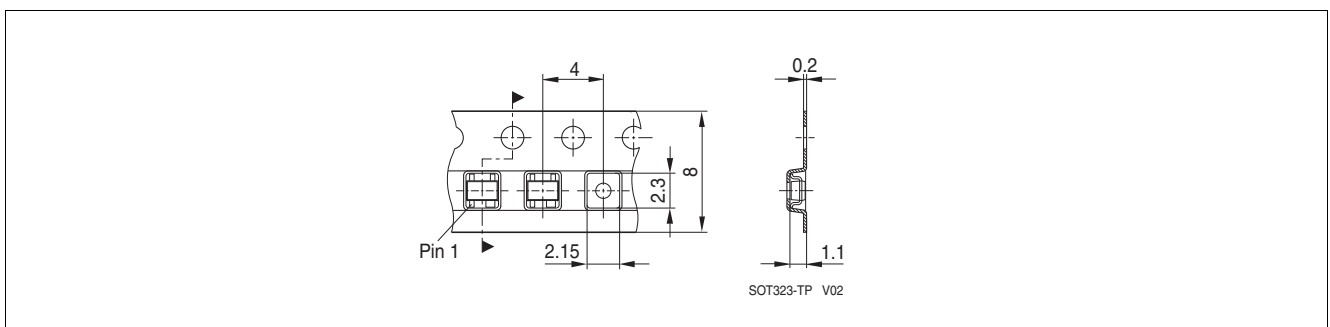


Figure 7-4 Tape Dimensions

[www.infineon.com](http://www.infineon.com)